

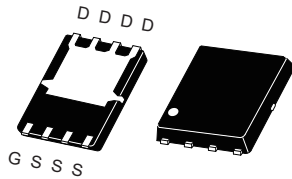
## P-Channel Enhancement Mode Field Effect Transistor

### FEATURES

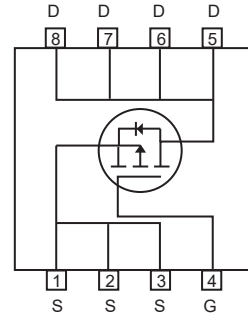
- -200V, -12.5A,  $R_{DS(ON)} = 275\text{ m}\Omega$  @  $V_{GS} = -10\text{V}$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handling capability.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.
- Surface mount Package.

### Applications

- Switched mode power supplies.
- Lighting.
- DC Motor control.
- Load switch.
- battery powered.



P-PAK 5X6



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

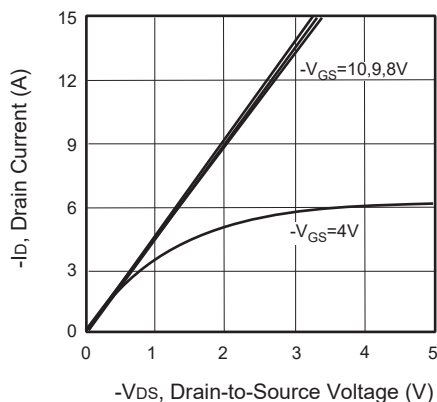
Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	-200	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V
Drain Current-Continuous	$I_D @ R_{\theta JC}$	-12.5	A
Drain Current-Continuous	$I_D @ R_{\theta JA}$	-3.6	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM} @ R_{\theta JC}$	-50	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM} @ R_{\theta JA}$	-14.4	A
Maximum Power Dissipation	$P_D$	73.5	W
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 150	$^\circ\text{C}$

### Thermal Characteristics

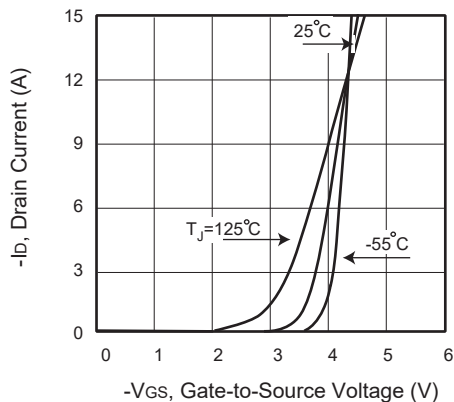
Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.7	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient <sup>b</sup>	$R_{\theta JA}$	20	$^\circ\text{C/W}$

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

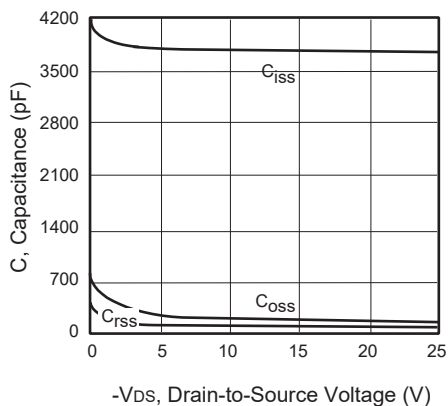
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-200			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -200V, V_{GS} = 0V$			-1	$\mu A$
Gate Body Leakage Current, Forward	$I_{GSSF}$	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
Gate Body Leakage Current, Reverse	$I_{GSSR}$	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
<b>On Characteristics <sup>c</sup></b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}, I_D = -250\mu A$	-2		-4	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -5.2A$		220	275	$m\Omega$
<b>Dynamic Characteristics <sup>d</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -25V, V_{GS} = 0V,$ $f = 1.0\text{ MHz}$		3790		pF
Output Capacitance	$C_{oss}$			145		pF
Reverse Transfer Capacitance	$C_{rss}$			105		pF
<b>Switching Characteristics <sup>d</sup></b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -100V, I_D = -6A,$ $V_{GS} = -10V, R_{GEN} = 25\Omega$		41		ns
Turn-On Rise Time	$t_r$			38		ns
Turn-Off Delay Time	$t_{d(off)}$			191		ns
Turn-Off Fall Time	$t_f$			71		ns
Total Gate Charge	$Q_g$	$V_{DD} = -160V, I_D = -6A,$ $V_{GS} = -10V$		65		nC
Gate-Source Charge	$Q_{gs}$			10		nC
Gate-Drain Charge	$Q_{gd}$			21		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S$				-12.5	A
Drain-Source Diode Forward Voltage <sup>c</sup>	$V_{SD}$	$V_{GS} = 0V, I_S = -10.5A$			-1.2	V
<b>Notes :</b> a. Repetitive Rating : Pulse width limited by maximum junction temperature. b. Surface Mounted on FR4 Board, $t \leq 10\text{ sec}$ . c. Pulse Test : Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ . d. Guaranteed by design, not subject to production testing. e. L = 3mH, $I_{AS} = 11.5A$ , $V_{DD} = 25V$ , $R_G = 25\Omega$ , Starting $T_J = 25^\circ\text{C}$ .						



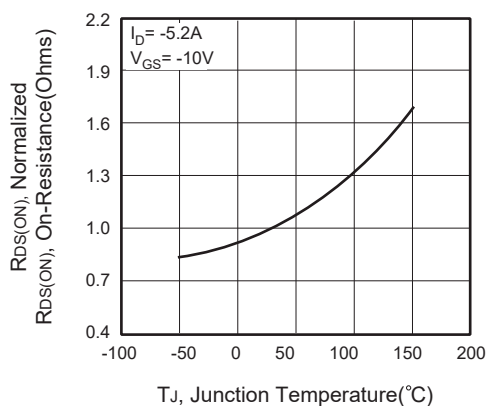
**Figure 1. Output Characteristics**



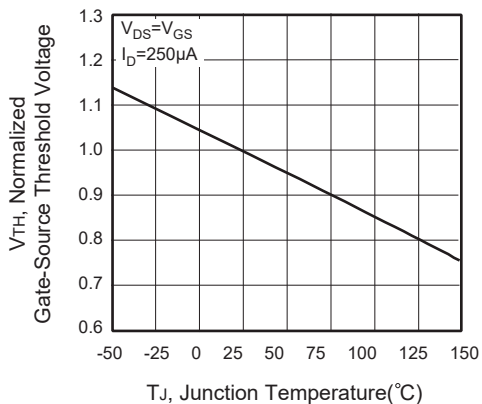
**Figure 2. Transfer Characteristics**



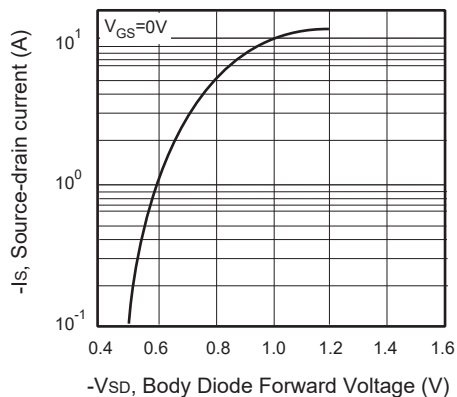
**Figure 3. Capacitance**



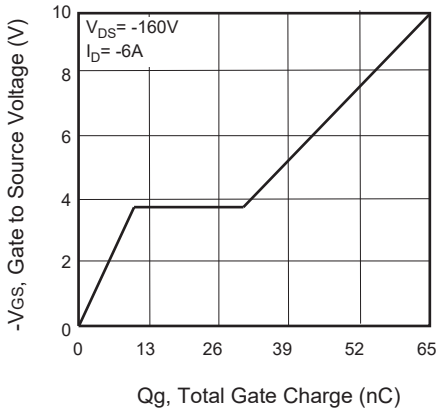
**Figure 4. On-Resistance Variation with Temperature**



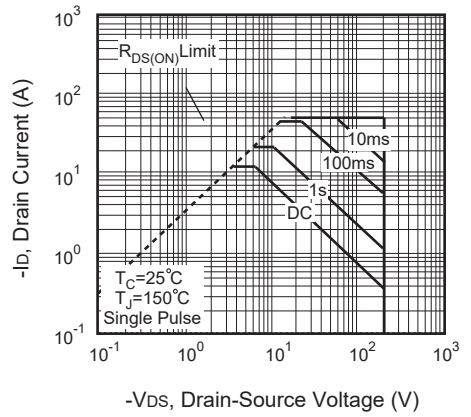
**Figure 5. Gate Threshold Variation with Temperature**



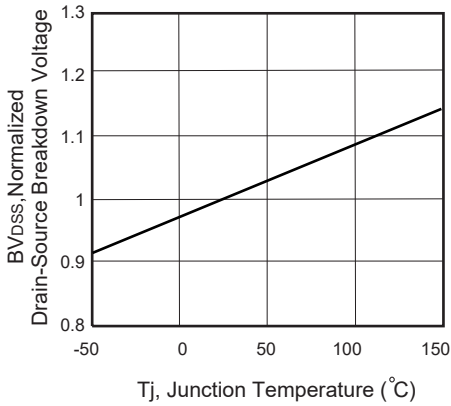
**Figure 6. Body Diode Forward Voltage Variation with Source Current**



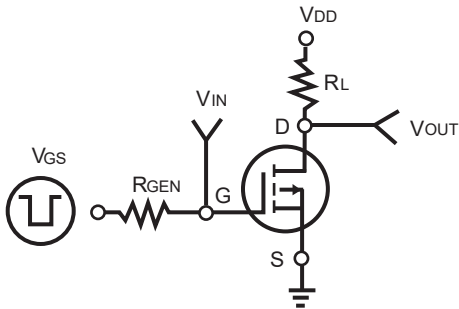
**Figure 7. Gate Charge**



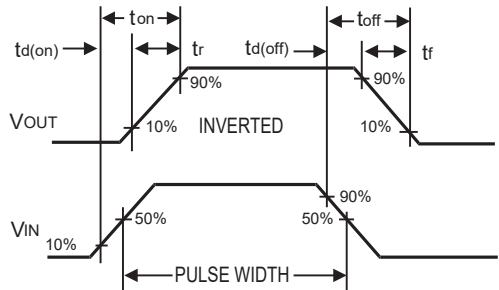
**Figure 8. Maximum Safe Operating Area**



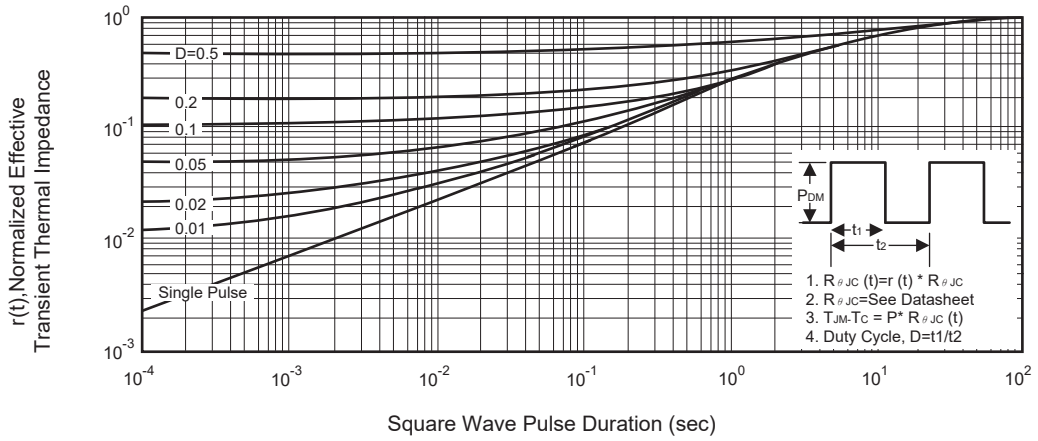
**Figure 9. Breakdown Voltage Variation VS Temperature**



**Figure 10. Switching Test Circuit**



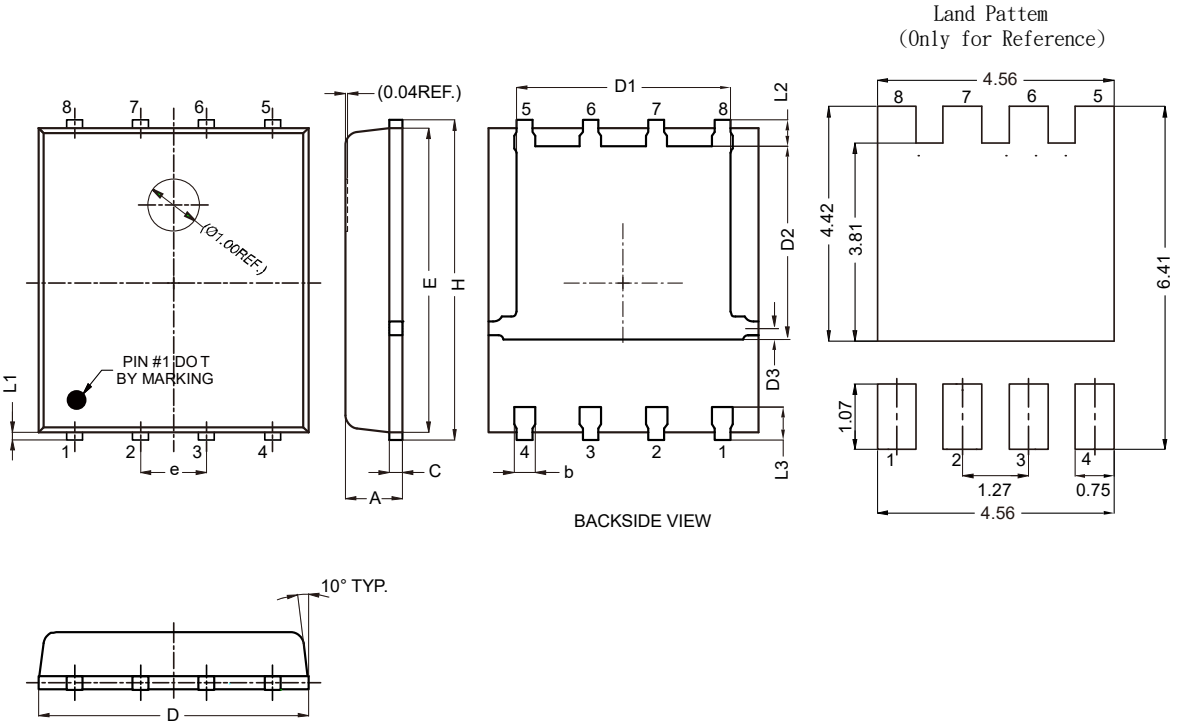
**Figure 11. Switching Waveforms**



**Figure 11. Normalized Thermal Transient Impedance Curve**

## P-PAK5X6 產品外觀尺寸圖 (Product Outline Dimension)

### SINGLE PAD 尺寸圖



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.000	1.200	0.039	0.047
b	0.330	0.500	0.013	0.020
c	0.200	0.300	0.008	0.012
D	5.000	5.400	0.197	0.213
D1	3.800	4.250	0.150	0.167
D2	3.520	3.920	0.139	0.154
D3	0.396	0.436	0.016	0.017
E	5.760	5.960	0.227	0.235
e	1.270 TYP		0.050 TYP	
H	6.000	6.300	0.236	0.248
L1	0.080	0.220	0.003	0.009
L2	0.400	0.600	0.016	0.024
L3	0.500	0.700	0.020	0.028